

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

Assignment ID: PATI46332

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
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Horyul Lee	10/13/2020
Yoshihiko Ichikawa	10/08/2020
Yunkyu Shim	10/08/2020
RECEIVING PARTY DATA	
Company Name:	HP Printing Korea Co., Ltd.
Street Address:	129, Samsung-Ro, Yeongtong-Gu Suwon-Si
City:	Gyeonggi-do
State/Country:	KOREA, REPUBLIC OF
Postal Code:	443-742
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18027618
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	86237324
NAME OF SUBMITTER:	Maria Lopes-Carvalho
SIGNATURE:	Maria Lopes-Carvalho
DATE SIGNED:	02/22/2024
Total Attachments: 4	
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HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 85939658

ASSIGNMENT OF PATENT APPLICATION

I, the undersigned, to the extent not already owned by or assigned and transferred to HP PRINTING KOREA CO., LTD., according to applicable law by virtue of my employment or agreement related thereto, for good and valuable consideration, the receipt of which is hereby acknowledged, agree to assign and transfer and hereby assign and transfer to

HP PRINTING KOREA CO., LTD., a Korean company, having a principal business address in 152 Pangyoeyeok-ro, Bundang-gu, Seongnam-si, Gyeonggi-do, REPUBLIC OF KOREA, (hereinafter "HP PK"),

its successors, and its assigns, my entire right, title, and interest, including all rights of priority, in, to, and under an application for patent entitled (English-language title in parentheses if said application for patent is in another language):

Title: 현상기 내부의 규제 블레이드 냉각 구조
{cooling structure for regulation blade of developing device}

Filing Date: October 14, 2020 Application No.: 10-2020-0132342 Patent Office: KR ;

the subject matter, including any and all inventions, improvements, and discoveries, set forth in said application for patent (as used herein "patent" refers to any form of intellectual property protection including, without limitation, invention rights, utility patent rights, design rights, and utility model rights) (hereinafter "Inventions"); any and all existing and future applications for patent of any country or region or under any international agreement for any of said Inventions (including, without limitation, said application for patent, any and all applications for patent directly or indirectly claiming priority to or benefit of any application for patent for any of said Inventions, any and all applications for patent from which any application for patent for any of said Inventions directly or indirectly claims priority or benefit, and any and all continuation applications of, continuation-in-part applications (hereinafter "CIPs") of, divisional applications of, national-phase applications of, regional-phase applications of, renewals of, and substitutes for any application for patent for any of said Inventions) (hereinafter "Applications for Patent"); any and all patents which may be granted on or as a result of said Applications for Patent (hereinafter "Patents"); and any and all reissues, reexaminations, and extensions of said Applications for Patent or said Patents.

I HEREBY represent that I convey my full rights in all countries and regions and under all international agreements to the entire right, title, and interest herein assigned and transferred, and that I have not executed and will not execute any agreement in conflict herewith;

AND I HEREBY authorize HP PK, its successors, its assigns, its nominees, and its legal representatives to file said Applications for Patent in its name or in my name in any country or region or under any international agreement, and further authorize HP PK, its successors, its assigns, its nominees, and its legal representatives to insert the filing date, application number, and patent office of said application for patent, now identified by the Record ID and title set forth above, when known to them;

AND I HEREBY authorize and request the officials of all countries and regions and under all international agreements whose duty it is to issue patents, to issue to HP PK, its successors, or its assigns, as assignee of my entire right, title, and interest, said Patents, in accordance with the terms of this assignment and transfer;

AND I HEREBY covenant and agree that I will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title in said Inventions, Applications for Patent, and Patents, to HP PK, its successors, or its assigns; communicate to HP PK, its successors, its assigns, its nominees, or its legal representatives, all known facts respecting said Inventions, Applications for Patent, and Patents; testify in any legal or administrative proceedings and sign all lawful papers (including, without limitation, divisional applications, continuation applications, CIPs, and reissue applications) relating to said Inventions, Applications for Patent, and Patents; and make all rightful oaths and declarations and generally to do everything possible to aid HP PK, its successors, its assigns, its nominees, and its legal representatives to obtain, maintain, and enforce, for its or their own benefit, proper intellectual property protection for said Inventions, Applications for Patent, and Patents, provided the expenses which may be incurred by me in lending such cooperation and assistance are paid by HP PK, its successors, its assigns, its nominees, or its legal representatives.

IN WITNESS WHEREOF, I hereunto set my hand and seal:

Minguk GO.
Inventor's Signature

8 10 2020
Day Month Year

Minguk GO
Inventor's Legal Name

PATENT
REEL: 066536 FRAME: 0821

HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

Horyul Lee
Inventor's Signature

13 10 2020
Day Month Year

Horyul LEE
Inventor's Legal Name

PATENT
REEL: 066536 FRAME: 0822

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Fort Collins, Colorado 80528

RECORD ID: 85939658

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

Yoshihiko Ichikawa
Inventor's Signature

8 10 2020
Day Month Year

Yoshihiko ICHIKAWA
Inventor's Legal Name

Rev 8/2020

PATENT
REEL: 066536 FRAME: 0823

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Yunkyū Shim
Inventor's Signature

08 10 2020
Day Month Year

Yunkyū SHIM
Inventor's Legal Name